NEC's 4.8 TO 5.85 GHz HIGH POWER GaAs MMIC SPDT SWITCH

UPG2022TB

FEATURES

• OPERATING FREQUENCY:

f = 4.8 to 5.85 GHz

- LOW INSERTION LOSS:
 0.8 dB TYP. @ 4.9 to 5.2 GHz
 0.9 dB TYP. @ 5.8 GHz
- POWER HANDLING: Pin (0.1dB) = +30 dBm TYP. @ 4.9 to 5.2 GHz Pin (0.1dB) = +31 dBm TYP. @ 5.2 to 5.85 GHz
- CONTROL VOLTAGE:

 $V_{cont} = +2.8 V/0 V$

- HIGH ISOLATION: (Between INPUT and OUTPUT) = 29 dB TYP. @ 5.85 GHz (Between OUTPUT1 and OUTPUT2) = 18 dB TYP. @ 5.85 GHz
- INPUT/OUTPUT RETURN LOSS: 10 dB MIN. @ 4.8 to 5.85 GHz
- SWITCHING SPEED: 20 ns @ trise/tfall (10/90% RF)
- 6-PIN SUPER MINIMOLD PACKAGE: (2.0 × 1.25 × 0.9 mm)
- LEAD FREE

DESCRIPTION

NEC's UPG2022TB is a high power GaAs MMIC SPDT (Single Pole Double Throw) switch. This device can operate from 4.8 to 5.85 GHz with low insertion loss. It is housed in a compact, lead free 6-pin super minimold package.

APPLICATIONS

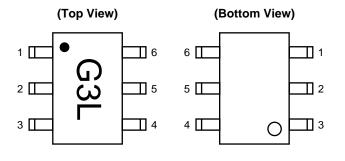
- 5 GHz BAND WLAN
- 5 GHz CORDLESS PHONES
- 5 GHz ELECTRONIC TOLL COLLECTION
- 5 GHz FIXED WIRELESS ACCESS

ORDERING INFORMATION

PART NUMBER	PACKAGE	MARKING	SUPPLYING FORM
UPG2022TB-E4-A	6-pin super minimold	G3L	 Embossed tape 8 mm wide Pin 4,5,6 face the perforation side of the tape Qty 3 kpcs/reel

Remark To order evaluation samples, contact your nearby sales office. Part number for sample order: UPG2022TB-A

PIN CONNECTIONS



PIN NO.	PIN NAME
1	OUTPUT2
2	GND
3	OUTPUT1
4	V _{cont1}
5	INPUT
6	V _{cont2}

ABSOLUTE MAXIMUM RATINGS (TA =+25°C, unless otherwise specified)

PARAMETER	SYMBOL	RATINGS	UNIT
Switch Control Voltage	Vcont1, 2	-6.0 to +6.0 Note1	V
Input Power	Pin	+36	dBm
Total Power Dissipation	Ptot	0.15 Note2	W
Operating Ambient Temperature	TA	-45 to +85	°C
Storage Temperature	Tstg	-65 to +150	°C

Notes 1. $|V_{cont1} - V_{cont2}| \le 6.0 V$

2. Mounted on double-sided copper-clad $50 \times 50 \times 1.6$ mm epoxy glass PWB, T_A = +85°C

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
Switch Control Voltage (H)	Vcont (H)	2.7	2.8	3.3	V
Switch Control Voltage (L)	Vcont (L)	-0.2	0	0.2	V
Operating Frequency	f	4.8		5.85	GHz
Operating Ambient Temperature	TA	-40	+25	+85	°C

RECOMMENDED OPERATING RANGE (TA =+25°C, unless otherwise specified)

ELECTRICAL CHARACTERISTICS (TA = +25°C, Vcont = 2.8 V/0 V, Zo = 50 Ω , DC blocking capacitors = 3 pF,

Each port, unless otherwise specified)

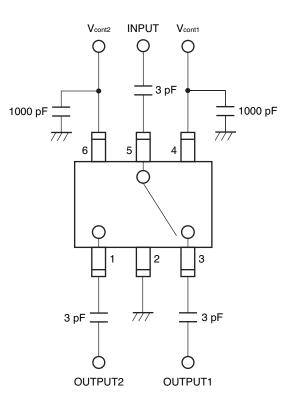
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Insertion Loss	Lins	f = 4.9 GHz	-	0.8	1.1	dB
		f = 5.2 GHz	-	0.8	1.1	dB
		f = 5.8 GHz	-	0.9	1.1	dB
Isolation 1	ISL1	f = 4.9 GHz	12	15	-	dB
(between OUTPUT1 and		f = 5.2 GHz	13	16	-	dB
OUTPUT2)		f = 5.8 GHz	15	18	-	dB
Input Return Loss	RLin	f = 4.9 GHz	10	17	-	dB
		f = 5.2 GHz	10	18	-	dB
		f = 5.8 GHz	10	15	-	dB
Output Return Loss	RLout	f = 4.9 GHz	10	19	-	dB
		f = 5.2 GHz	10	21	-	dB
		f = 5.8 GHz	10	19	-	dB
0.1 dB Gain Compression Input	Pin (0.1 dB)	f = 4.9 to 5.2 GHz	28	30	-	dBm
Power		f = 5.2 to 5.85 GHz	30	31	-]
Switching Control Speed	tsw	trise/tfall (10/90% RF)	-	20	-	ns
Switching Control Current	Icont		-	0.5	1	μΑ

STANDARD CHARACTERISTICS FOR REFERENCE

(TA = +25°C, Vcont = 2.8 V/0 V, Zo = 50 Ω, DC blocking capacitors = 3 pF, Each port, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Isolation 2	ISL2	f = 4.9 GHz	-	17	-	dB
(between INPUT and OUTPUT)		f = 5.2 GHz	-	20	-	dB
		f = 5.8 GHz	-	29	-	dB

EVALUATION CIRCUIT



The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

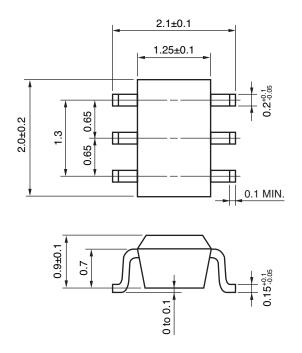
TRUTH TABLE OF SWITCHING BY CONDITION OF CONTROL VOLTAGE

		Vcont1				
		V	CONT (H)			
Vcont2	VCONT (H)		Note			
	VCONT (L)		OUTPUT1		Note O O OUTPUT1 O OUTPUT2	

Note In case of V_{CONT1} = V_{CONT2} = High or V_{CONT1} = V_{CONT2} = Low, (that is same control voltage for both pins), input signal of INPUT (Pin 5) is output from OUTPUT1 (Pin 3) and OUTPUT2 (Pin 1).

PACKAGE DIMENSIONS

6-PIN SUPER MINIMOLD (UNIT:mm)



RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions	Condition Symbol	
Infrared Reflow	Peak temperature (package surface temperature)	: 260°C or below	IR260
	Time at peak temperature	: 10 seconds or less	
	Time at temperature of 220°C or higher	: 60 seconds or less	
	Preheating time at 120 to 180°C	: 120±30 seconds	
	Maximum number of reflow processes	: 3 times	
	Maximum chlorine content of rosin flux (% mass)	: 0.2%(Wt.) or below	
VPS	Peak temperature (package surface temperature)	: 215°C or below	VP215
	Time at temperature of 200°C or higher	: 25 to 40 seconds	
	Preheating time at 120 to 150°C	: 30 to 60 seconds	
	Maximum number of reflow processes	: 3 times	
	Maximum chlorine content of rosin flux (% mass)	: 0.2%(Wt.) or below	
Wave Soldering	Peak temperature (molten solder temperature)	: 260°C or below	WS260
	Time at peak temperature	: 10 seconds or less	
	Preheating temperature (package surface temperature)	: 120°C or below	
	Maximum number of flow processes	: 1 time	
	Maximum chlorine content of rosin flux (% mass)	: 0.2%(Wt.) or below	
Partial Heating	Peak temperature (pin temperature)	: 350°C or below	HS350
	Soldering time (per side of device)	: 3 seconds or less	
	Maximum chlorine content of rosin flux (% mass)	: 0.2%(Wt.) or below	

Caution Do not use different soldering methods together (except for partial heating).

Life Support Applications

These NEC products are not intended for use in life support devices, appliances, or systems where the malfunction of these products can reasonably be expected to result in personal injury. The customers of CEL using or selling these products for use in such applications do so at their own risk and agree to fully indemnify CEL for all damages resulting from such improper use or sale.

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